

TK942 - Koh Young 3D KY8030-L Solder Paste Inspection Machine (2008)

Model: 3D KY8030-L Solder Paste Inspection Machine

SKU:

Year: 2008



Description:

Koh Young 3D KY8030-L Solder Paste Inspection Machine (2008)

Brand: Koh Young 3D SPI

Model: KY8030-L

Year: 2008

Serial #: SPI-8L110

Machine Size: Large

Max Panel Dimensions: 510mm x 510mm

Min Panel Dimensions: 50mm x 50mm

Maximum Panel Weight: 2kg

PCB Thickness Range: 0.4~5mm

PCB Handling: Belt

Hardware: 3D Inspection, Auto Conveyor Adjustment

Operations Software: Koh Young 3D Inspection HMI(3.5.2135)

Additional Options: EPM (Progam Create)

Measurement and Inspection Performance FPY? 50~80%

SPI-S10 VER

GUI Version: 3.5.2135

Vision Version: 1.1.11067

VisionTool 5.4.0 ,VPC 7.98

MCS Version: 760.09.17

PCB Viewer: 3.4.476

Remote Version: 1.0.7

STMC Rom Version: 0

D_TOOL Version

Motion B/D MMI Version

Motion B/D OS Version: 3.18.01

ePM-SPI Version: 1.1.9.0

SPC plus Version: 1.2.0.601

Grabber Version

